



Demonstration Board for the SA306



INTRODUCTION

The DB73HU is designed to demonstrate the capabilities of the SA306 3 phase brushless DC (BLDC) motor driver IC. This fully assembled demonstration allows the user to directly control the speed and direction of the motor. An onboard controller decodes HALL Effect sensor inputs for commutation in either direction and provides four quadrant PWM signals to control the power outputs of the SA306. LEDs provide visual feedback for motor control status and fault conditions. Provisions on the DB73HU allow the user to bypass the onboard control circuit and directly interface with the SA306 brushless motor driver.

The DB73HU demonstrates proper layout techniques for the SA306 high current switching amplifier. The economical construction uses only a two-sided PCB and allows the SA306 to deliver peak power of over 1kW.

THERMAL CONSIDERATIONS

The SA306 is offered in a surface mount package which can deliver peak power of over 1kW. This presents an obvious and significant thermal challenge. The DB73HU offers a compact design which can deliver 17A peak current. The DB73HU assembly can dissipate approximately 20W in still air at 25°C ambient temperature. To use the DB73HU in higher power applications, use of a fan is recommended. Although the SA306 is rated for operation from -25 to +85°C, the other components on the DB73HU are limited to 0 to 70°C ambient temperature.

CIRCUIT OPERATION

The DB73HU control circuit receives power via two terminal block connections. The Vs connection supplies power to drive the motor and must be above the under-voltage lock-out threshold of the SA306, approximately 8.3V. The control circuit requires 12V for proper operation. A regulator on the DB73HU provides the 5V logic supply for the SA306. There are no special considerations for sequencing the two supplies.

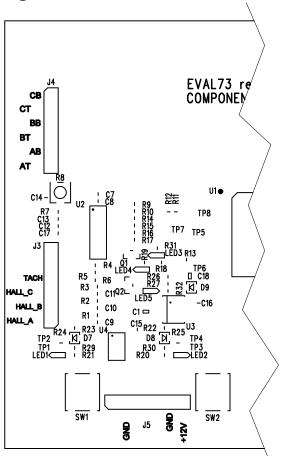
Figure 1 shows the user control features of the DB73HU. The PWM duty cycle is controlled with the potentiometer. LED5 will illuminate when the 12V supply is connected. The DB73HU will power up with the SA306 disabled. SW2 will toggle the SA306 on and off with LED2 illuminating to indicate the enable status. Direction of the motor is similarly controlled with SW1 and is indicated by LED1.

The DB73HU monitors the temperature warning status pin of the SA306. If this pin goes high LED4 illuminates and the enable circuit is forced to a disable status. The temperature LED is not latched and may stay illuminated only briefly while the temperature of the SA306 is above 135°C. The temperature decrease rapidly via the heatsink once the SA306 is disabled.

The SA306 current limit feature is set to limit at approximately 15A to provide a demonstration of the full capabilities of the SA306. LED3 will illuminate if the SA306 cycle-by-cycle current limit circuit engages. The thermal and current limit fea-



Figure 1 – User Control Features

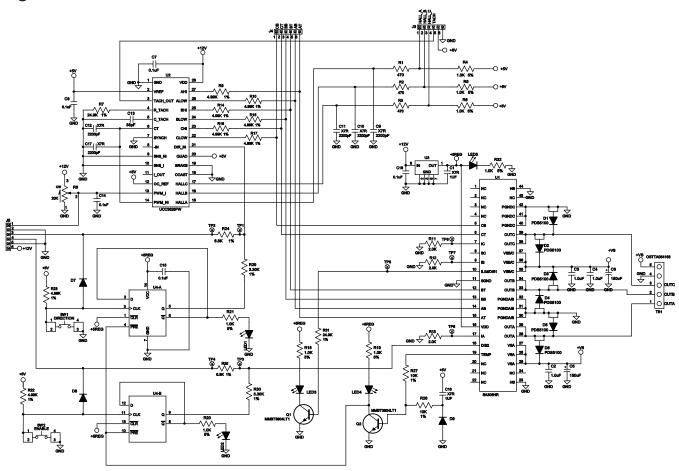




tures are robust, but will not protect the SA306 in all circumstances. The user must consider the worst case thermal and power dissipation conditions.

Hall Effect inputs to connector J3 (9) are required to commutate the motor correctly. Filtering networks and 5V pullup are provided for glitch-free operation. The Hall sensor connector, J3 (9), also includes a tachometer output which is based on the commutation signals from the Hall inputs. Power for the Hall sensors is provided by U2 in Figure 2, an integrated brushless motor controller IC. The controller decodes the Hall sensor inputs and generates six PWM control signals directly to the SA306. Push-button switches 1 and 2 trigger latches (U4) for direction and enable control, respectively. Diodes D7 & D8 and resistors R24, 25, 29 & 30 provide a means of bypassing the DB73HU control circuit. The 5V regulator, U3, provides 5V to the SA306, the latches, and the status LEDs.

Figure 2 – Schematic



ENHANCING & BYPASSING THE DB73HU CONTROL CIRCUIT

Connector J5 allows the user to bypass many of the manual control features of the DB73HU. A signal generator can control the duty cycle with a 2.5 to 7.5V signal, overriding the control potentiometer. A rising 5V edge on pin 3 or 4 of connector J5 will toggle the Direction or Enable latches, respectively. By jumping resistors R24 & R25, the latches are bypassed completely and the logic signals on pins 3 & 4 will directly control the direction and enable functions of the DB73HU. With these resistors jumped, the direction and enable LEDs will not represent the states of the DB73HU and the pushbuttons will have no effect on the operation. The Temperature disable feature of the DB73HU will also not function, although the LED will continue to provide over-temperature status.

Connector J4 is connected directly to the PWM input pins of the SA306. This connector may be used to monitor the signals or to bypass the control IC on the DB73HU. The enable function is not controlled via these pins, although pulling all six input pins low provides the same effect. The Enable pushbutton and the connection via J5 are also

2 DB73HUU



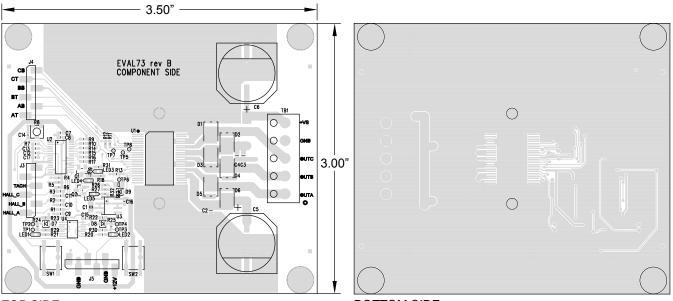
effective as previously described. The circuit shown in Figure 2 in the dashed box is a simple circuit that allows the user to monitor and control the enable or direction status remotely. Either feature can be toggled on the falling edge of the signal at the node labeled TOGGLE.

LAYOUT CONSIDERATIONS

A simple two layer construction is sufficient because of the convenient pinout of the SA306 HSOP package. Input signals are routed into one side of the package and high power output signals are routed from the other side in 2 ounce copper. This eliminates the need to route control signals near motor connections where noise may corrupt the signals. Filling top and bottom layers with copper reduces inductive coupling from the high current outputs. 1nF capacitors with excellent high frequency characteristics bypass the Vs motor supplies on each phase. Two 150µF electrolytic capacitors provide a local, low inductance source to accommodate surge currents up to 17A. Six 100V Schottky diodes conduct the commutation current via low forward voltage paths which reduces the power dissipation in the SA306. These diodes are rated for 5A continuous and are mounted close to the SA306 to reduce inductance in the commutating current loop. For applications with continuous currents less than 5A, the Schottky diodes may not be necessary if the higher forward voltage internal body diodes and the associated power dissipation are manageable during commutation cycles.

Figure 3 shows the top and bottom layouts of the EVAL73. Gerber files for the circuit board are available upon request.

Figure 3 – PCB Layout (not to scale)



TOP SIDE BOTTOM SIDE

DB73HUU 3



BILL OF MATERIALS

C1,C18 C13 CAP, 1.0uF, 16V C2,C3,C4 CAP, 33pF, 50V Kemet, C0805C105JK4RAC C5,C6 CAP, 1.0nF, 100V C5,C6 CAP, 1.0nF, 100V C7,C8,C14,C15,C16 CAP, 0.1uF, 16V C7,C8,C14,C15,C16 CAP, 0.1uF, 16V CP,C10,C11,C12,C17 CAP, 2.2nF, 50V CAP, 2.0nF, 100V CAP, 2.0nF, 2.0nF, 100V CAP, 2.0nF, 2.0nF, 2.0nF CAP, 2.0nF, 2.0nF CAP, 2.0nF	Designation	Description	P/N
C2,C3,C4 C5,C6 CAP, 1.0nF,100V C5,C6 CAP, 150uF, 100V C7,C8,C14,C15,C16 CAP, 0.1uF, 16V C9,C10,C11,C12,C17 CAP, 2.2nF, 50V D1,D2,D3,D4,D5,D6 Diode, 5A Schottky D1,D2,D3,D4,D5,D6 D1,D2,D3,LED4,LED5 LED, Red C1,LED2,LED3,LED4,LED5 LED, Red C1,LED2,LED3,LED4,LED5 LED, Red C1,R1,R2,R3 RES, 470, 5% RK73B1JTTDD471J R11,R12,R13 RES, 2.0K, 1% R24,R25 RES, 10K R26,R27 RES, 10K R29,R30 R4,R5,R6,R18,R19,R20,R21,R32 R5, 2.49K,1/10W, 1% R8 R4,R5,R6,R18,R15,R16,R17,R22,R23 R5, 4.99K R8 R1,R1,R12,R23 R5,R10,R14,R15,R16,R17,R22,R23 R5,R10,R14,R15,R16,R17,R22,R23 R5,R3,R30 R5,	C1,C18	CAP, 1.0uF, 16V	Kemet, C0805C105K4RAC
C5,C6 C7,C8,C14,C15,C16 CAP, 0.1uf, 16V CRM188F51C104ZA01D CRM188F1LEZEKA01D CRM188F51C104ZA01D CRM188F1LEZEKA01D CRM188F1LEZEK01D CRM188F1LEZEKA01D CRM188F1LEZEKA01D CRM188F1LEZEKA01D CRM188F1LEZEKA01D CRM188F1LEZEKA01D CRM188F1LEZEKA01D CRM188F1LEZEKA01D CRM188F1LEZEK068 CRM188F1LEZEK068 CRM188F1LEZEK068 CRM188F1LEZEK068 CRM18BT0CHCS CRM18BTOCH CRM18BTOCH CRM18BTOCH CRM18BTOCH	C13	CAP, 33pF, 50V	Kemet C0603C330J5GACTU
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C9,C10,C11,C12,C17 CAP, 2.2nF, 50V GRM188R71H222KA01D D1,D2,D3,D4,D5,D6 Diode, 5A Schottky Diodes Inc. DS5100 D7,D8,D9 IN4148 Vishay, 1N4148WS-V-GS08 J3,J4,J5 Conn, 6 pin .100 ctrs Samtec TSM-106-01-T-SV LED1,LED2,LED3,LED4,LED5 LED, Red Lite-On LTST-C190CKT Q1,Q2 XTR, NPN, 40V MMBT3904LT1 R1,R2,R3 RES, 470, 5% RK73BJJTDD471J R11,R12,R13 RES 2.0K, 1% Vishay,CRCW06032K00FKEA R24,R25 RES, 6.8K Vishay,CRCW060310K0FKEA R29,R30 RES, 10K Vishay,CRCW060310K0FKEA R4,R5,R6,R18,R19,R20,R21,R32 RES, 1.0K, 5% RK73BJJT10102J R7,R31 RES, 2.4.9K,1/10W, 1% POT, 20K PVG3A203C01R00 R9,R10,R14,R15,R16,R17,R22,R23 RES, 4.99K Vishay, CRCW06034K99FKEA SW1,SW2 Pushbutton, SPST-NO Panasonic, EVQ-Q2B01W TB1 Term. Blk., 5.08mm Vort. 5 pos, PCB V3A306HU-FH Texas Instruments, UCC3626PW U3 LM78L05 National Semiconductor, LM78L05ACMX/NOPB Texas Instru	C5,C6	CAP, 150uF, 100V	Panasonic, EEVFK2A151M
D1,D2,D3,D4,D5,D6 Diode, 5A Schottky Diodes Inc. DS5100 D7,D8,D9 IN4148 Vishay, 1N4148WS-V-GS08 J3,J4,J5 Conn, 6 pin .100 ctrs Samtec TSM-106-01-T-SV LED1,LED2,LED3,LED4,LED5 LED, Red Lite-On LTST-C190CKT Q1,Q2 XTR, NPN, 40V MMBT3904LT1 R1,R2,R3 RES, 470, 5% RK73B1JTTDD471J R1,R12,R13 RES, 20K, 1% Vishay,CRCW06032K00FKEA R24,R25 RES, 6.8K Vishay,CRCW060310K0FKEA R26,R27 RES, 10K Vishay,CRCW060310K0FKEA R29,R30 RES, 3.3K Vishay,CRCW060310K0FKEA R4,R5,R6,R18,R19,R20,R21,R32 RES, 1.0K, 5% RK73B1JTTD102J R7,R31 RES, 24.9K,1/10W, 1% PK73B1JTTD102J R9,R10,R14,R15,R16,R17,R22,R23 RES, 4.99K Vishay, CRCW06034K99FKEA SW1,SW2 Pushbutton, SPST-NO Panasonic, EVQ-Q2B01W TB1 JCC3626 Texas Instruments, UCC3626PW U1 LM78L05 National Semiconductor, LM78L05ACMX/NOPB U4 T4AC74 Texas Instruments, SN74AC74PW Apex Microtechnology, EVAL73	C7,C8,C14,C15,C16	CAP, 0.1uF, 16V	GRM188F51C104ZA01D
D7,D8,D9 IN4148 Vishay, 1N4148WS-V-GS08 J3,J4,J5 Conn, 6 pin .100 ctrs Samtec TSM-106-01-T-SV LED1,LED2,LED3,LED4,LED5 LED, Red Lite-On LTST-C190CKT Q1,Q2 XTR, NPN, 40V MMBT3904LT1 R1,R2,R3 RES, 470, 5% RK73B1JTTDD471J R1,R1,R12,R13 RES, 20K, 1% Vishay,CRCW06032K00FKEA R24,R25 RES, 10K Vishay,CRCW060310K0FKEA R26,R27 RES, 10K Vishay,CRCW060310K0FKEA R29,R30 RES, 3.3K Vishay,CRCW060310K0FKEA R4,R5,R6,R18,R19,R20,R21,R32 RES, 1.0K, 5% RK73B1JTTD102J R7,R31 RES, 24,9K,1/10W, 1% RK73B1JTTD492F R8 POT, 20K PVG3A203C01R00 R9,R10,R14,R15,R16,R17,R22,R23 RES, 4.99K Vishay, CRCW06034K99FKEA SW1,SW2 Pushbutton, SPST-NO Term. Blk., 5.08mm OSTTA054163 U1 SA306HU-FH Apex Microtechnology, SA306HU-FH U2 UCC3626 Texas Instruments, UCC3626PW U3 LM78L05 National Semiconductor, LM78L05ACMX/NOPB U4 T4AC74 <td>C9,C10,C11,C12,C17</td> <td>CAP, 2.2nF, 50V</td> <td>GRM188R71H222KA01D</td>	C9,C10,C11,C12,C17	CAP, 2.2nF, 50V	GRM188R71H222KA01D
J3,J4,J5 Conn, 6 pin .100 ctrs Samtéc TSM-106-01-T-SV LED1,LED2,LED3,LED4,LED5 LED, Red Lite-On LTST-C190CKT Q1,Q2 XTR, NPN, 40V MMBT3904LT1 R1,R2,R3 RES, 470, 5% RK73B1JTTDD471J R11,R12,R13 RES 2.0K, 1% Vishay,CRCW06032K00FKEA R24,R25 RES, 6.8K Vishay,CRCW06036K80FKEA R26,R27 RES, 10K Vishay,CRCW060310K0FKEA R4,R5,R6,R18,R19,R20,R21,R32 RES, 1.0K, 5% RK73B1JTTD102J R7,R31 RES, 24.9K,1/10W, 1% RK73B1JTTD2492F R8 POT, 20K PVG3A203C01R00 R9,R10,R14,R15,R16,R17,R22,R23 RES, 4.99K Vishay, CRCW06034K99FKEA PVG3A203C01R00 PVG3A203C01R00 V9T PVG3A203C01R00 V9T Vishay, CRCW06034K99FKEA PAnasonic, EVQ-Q2B01W OSTTA054163 OSTTA054163 VCC3626PW U3 LM78L05 National Semiconductor, LM78L05ACMX/NOPB U4 74AC74 Texas Instruments, SN74AC74PW Heatsink Apex Microtechnology, EVAL73 Serew, #4-40 x 1/2"	D1,D2,D3,D4,D5,D6	Diode, 5A Schottky	Diodes Inc. DS5100
LED1,LED2,LED3,LED4,LED5 LED, Red Lite-On LTST-C190CKT Q1,Q2 XTR, NPN, 40V MMBT3904LT1 R1,R2,R3 RES, 470, 5% RK73B1JTTDD471J R11,R12,R13 RES 2.0K, 1% Vishay,CRCW06032K00FKEA R24,R25 RES, 6.8K Vishay,CRCW060310K0FKEA R26,R27 RES, 10K Vishay,CRCW060310K0FKEA R29,R30 RES, 3.3K Vishay,CRCW06033K30FKEA R4,R5,R6,R18,R19,R20,R21,R32 RES, 1.0K, 5% RK73B1JTTD102J R7,R31 RES, 24,9K,1/10W, 1% RK73H1JTTD2492F R8 POT, 20K PVG3A203C01R00 V93A203C01R00 Vishay, CRCW06034K99FKEA Panasonic, EVQ-Q2B01W Panasonic, EVQ-Q2B01W TB1 Vert. 5 pos, PCB U1 SA306HU-FH Apex Microtechnology, SA306HU-FH U2 UCC3626 Texas Instruments, UCC3626PW U3 LM78L05 National Semiconductor, LM78L05ACMX/NOPB U4 74AC74 Texas Instruments, SN74AC74PW Heatsink Apex Microtechnology, EVAL73 SCrew, #4-40 x 1/2" 18-8 SS Pan Head Phillips 91772A110	D7,D8,D9	IN4148	Vishay, 1N4148WS-V-GS08
Q1,Q2 XTR, NPN, 40V MMBT3904LT1 R1,R2,R3 RES, 470, 5% RK73B1JTTDD471J R11,R12,R13 RES 2.0K, 1% Vishay,CRCW06032K00FKEA R24,R25 RES, 6.8K Vishay,CRCW060310K0FKEA R26,R27 RES, 10K Vishay,CRCW060310K0FKEA R29,R30 RES, 3.3K Vishay,CRCW06033K30FKEA R4,R5,R6,R18,R19,R20,R21,R32 RES, 1.0K, 5% RK73B1JTTD102J R7,R31 RES, 24.9K,1/10W, 1% RK73H1JTD2492F R8 POT, 20K PVG3A203C01R00 R9,R10,R14,R15,R16,R17,R22,R23 RES, 4.99K Vishay, CRCW06034K99FKEA SW1,SW2 Pushbutton, SPST-NO Panasonic, EVG-Q2B01W TB1 Term. Blk., 5.08mm Vert. 5 pos, PCB U1 SA306HU-FH Apex Microtechnology, SA306HU-FH U2 UCC3626 Texas Instruments, UCC3626PW U3 LM78L05 National Semiconductor, LM78L05ACMX/NOPB U4 74AC74 Texas Instruments, SN74AC74PW Heatsink Apex Microtechnology, HS36, 2.8°C/W Apex Microtechnology, EVAL73 Solder Paste IN	J3,J4,J5	Conn, 6 pin .100 ctrs	Samtec TSM-106-01-T-SV
R1,R2,R3 RES, 470, 5% RK73B1JTTDD471J R11,R12,R13 RES 2.0K, 1% Vishay,CRCW06032K00FKEA R24,R25 RES, 6.8K Vishay,CRCW060310K0FKEA R26,R27 RES, 10K Vishay,CRCW060310K0FKEA R29,R30 RES, 3.3K Vishay,CRCW06033K30FKEA R4,R5,R6,R18,R19,R20,R21,R32 RES, 1.0K, 5% RK73B1JTTD102J R7,R31 RES, 24.9K,1/10W, 1% RK73H1JTTD2492F R8 POT, 20K PVG3A203C01R00 R9,R10,R14,R15,R16,R17,R22,R23 RES, 4.99K Vishay, CRCW06034K99FKEA SW1,SW2 Pushbutton, SPST-NO Panasonic, EVQ-Q2B01W TB1 Term. Blk., 5.08mm OSTTA054163 Vert. 5 pos, PCB Vishay, CRCw06034K99FKEA U1 Apex Microtechnology, SA306HU-FH U2 UCC3626 Texas Instruments, UCC3626PW U3 LM78L05 National Semiconductor, LM78L05ACMX/NOPB U4 74AC74 Texas Instruments, SN74AC74PW Heatsink Apex Microtechnology, EVAL73 Screw, #4-40 x 1/2" Apex Microtechnology, EVAL73 Screw, #4-40 x 1/2" Res	LED1,LED2,LED3,LED4,LED5		Lite-On LTST-C190CKT
R11,R12,R13 RES 2.0K, 1% Vishay,CRCW06032K00FKEA R24,R25 RES, 6.8K Vishay,CRCW06036K80FKEA R26,R27 RES, 10K Vishay,CRCW060310K0FKEA R29,R30 RES, 3.3K Vishay,CRCW06033K30FKEA R4,F5,R6,R18,R19,R20,R21,R32 RES, 1.0K, 5% RK73B1JTTD102J R7,R31 RES, 24.9K,1/10W, 1% RK73H1JTTD2492F R8 POT, 20K PVG3A203C01R00 R9,R10,R14,R15,R16,R17,R22,R23 RES, 4.99K Vishay, CRCW06034K99FKEA SW1,SW2 Pushbutton, SPST-NO Panasonic, EVQ-Q2B01W TB1 Term. Blk., 5.08mm OSTTA054163 Vert. 5 pos, PCB OSTTA054163 U1 UCC3626 Texas Instruments, UCC3626PW U3 LM78L05 National Semiconductor, LM78L05ACMX/NOPB U4 74AC74 Texas Instruments, SN74AC74PW Heatsink Apex Microtechnology, EVAL73 Screw, #4-40 x 1/2" 18-8 SS Pan Head Phillips 91772A110 Solder Paste INDC121NCSMQ90 83% MTL MSH-325+500 (U1) Gap Pad, Thermal Interface, 40mils thick,	Q1,Q2		MMBT3904LT1
R24,R25 RES, 6.8K Vishay,CRCW06036K80FKEA R26,R27 RES, 10K Vishay,CRCW060310K0FKEA R29,R30 RES, 3.3K Vishay,CRCW06033K30FKEA R4,R5,R6,R18,R19,R20,R21,R32 RES, 1.0K, 5% RK73B1JTTD102J R7,R31 RES, 24.9K,1/10W, 1% RK73B1JTTD102J R8 POT, 20K PVG3A203C01R00 R9,R10,R14,R15,R16,R17,R22,R23 RES, 4.99K Vishay, CRCW06034K99FKEA SW1,SW2 Pushbutton, SPST-NO Panasonic, EVQ-Q2B01W TB1 Term. Blk., 5.08mm OSTTA054163 Vert. 5 pos, PCB Vishay, CRCW06034K99FKEA U1 SA306HU-FH Apex Microtechnology, SA306HU-FH U2 UCC3626 Texas Instruments, UCC3626PW U3 LM78L05 National Semiconductor, LM78L05ACMX/NOPB U4 74AC74 Texas Instruments, SN74AC74PW Heatsink Apex Microtechnology, HS36, 2.8°C/W PCB, 3.0" x 3.5" Apex Microtechnology, EVAL73 Screw, #4-40 x 1/2" Solder Paste INDC121NCSMQ90 83% MTL MSH-325+500 (U1) Gap Pad, Thermal Interface, 40mils thick, GP5000S35-0.040-02-43-NA	R1,R2,R3	RES, 470, 5%	
R26,R27 RES, 10K Vishay,CRCW060310K0FKEA R29,R30 RES, 3.3K Vishay,CRCW06033K30FKEA R4,R5,R6,R18,R19,R20,R21,R32 RES, 1.0K, 5% RK73B1JTTD102J R7,R31 RES, 24.9K,1/10W, 1% RK73H1JTTD2492F R8 POT, 20K PVG3A203C01R00 R9,R10,R14,R15,R16,R17,R22,R23 RES, 4.99K Vishay, CRCW06034K99FKEA SW1,SW2 Pushbutton, SPST-NO Panasonic, EVQ-Q2B01W TB1 Term. Blk., 5.08mm OSTTA054163 Vert. 5 pos, PCB Vert. 5 pos, PCB U1 SA306HU-FH Apex Microtechnology, SA306HU-FH U2 UCC3626 Texas Instruments, UCC3626PW U3 LM78L05 National Semiconductor, LM78L05ACMX/NOPB U4 74AC74 Texas Instruments, SN74AC74PW Heatsink Apex Microtechnology, HS36, 2.8°C/W PCB, 3.0" x 3.5" Apex Microtechnology, EVAL73 Screw, #4-40 x 1/2" 18-8 SS Pan Head Phillips 91772A110 Solder Paste INDC121NCSMQ90 83% MTL MSH-325+500 (U1) Gap Pad, Thermal Interface, 40mills thick,	R11,R12,R13		
R29,R30 RES, 3.3K Vishay,CRCW06033K30FKEA R4,R5,R6,R18,R19,R20,R21,R32 RES, 1.0K, 5% RK73B1JTTD102J R7,R31 RES, 24.9K,1/10W, 1% RK73H1JTTD2492F R8 POT, 20K PVG3A203C01R00 R9,R10,R14,R15,R16,R17,R22,R23 RES, 4.99K Vishay, CRCW06034K99FKEA SW1,SW2 Pushbutton, SPST-NO Panasonic, EVQ-Q2B01W TB1 Term. Blk., 5.08mm OSTTA054163 Vert. 5 pos, PCB Vishay, CRCW060034K99FKEA U1 SA306HU-FH Panasonic, EVQ-Q2B01W U2 UCC3626 Texas Instruments, UCC3626PW U3 LM78L05 National Semiconductor, LM78L05ACMX/NOPB U4 74AC74 Texas Instruments, SN74AC74PW Heatsink Apex Microtechnology, HS36, 2.8°C/W PCB, 3.0" x 3.5" Apex Microtechnology, EVAL73 Screw, #4-40 x 1/2" 18-8 SS Pan Head Phillips 91772A110 Paste INDC121NCSMQ90 83% MTL MSH-325+500 (U1) Gap Pad, Thermal Interface, 40mils thick,	R24,R25	RES, 6.8K	
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R7,R31 RES, 24.9K,1/10W, 1% RK73H1JTTD2492F R8 POT, 20K PVG3A203C01R00 R9,R10,R14,R15,R16,R17,R22,R23 RES, 4.99K Vishay, CRCW06034K99FKEA SW1,SW2 Pushbutton, SPST-NO Term. Blk., 5.08mm Vert. 5 pos, PCB U1 SA306HU-FH Apex Microtechnology, SA306HU-FH U2 UCC3626 Texas Instruments, UCC3626PW U3 LM78L05 National Semiconductor, LM78L05ACMX/NOPB U4 74AC74 Texas Instruments, SN74AC74PW Heatsink Apex Microtechnology, HS36, 2.8°C/W PCB, 3.0" x 3.5" Apex Microtechnology, EVAL73 Screw, #4-40 x 1/2" Apex Microtechnology, EVAL73 Scr	· · · · · · · · · · · · · · · · · · ·		
R8 R9,R10,R14,R15,R16,R17,R22,R23 R9,R10,R14,R15,R16,R17,R22,R23 R9,R10,R14,R15,R16,R17,R22,R23 R8 R9,R10,R14,R15,R16,R17,R22,R23 RES, 4.99K Pushbutton, SPST-NO Term. Blk., 5.08mm Vert. 5 pos, PCB U1 SA306HU-FH U2 UCC3626 UM78L05 Vational Semiconductor, LM78L05ACMX/NOPB U4 Retsink PCB, 3.0" x 3.5" Screw, #4-40 x 1/2" Solder Gap Pad, Thermal Interface, 40mils thick, PVG3A203C01R00 Vishay, CRCW06034K99FKEA Panasonic, EVQ-Q2B01W OSTTA054163 VET. 5 pos, PCB Apex Microtechnology, SA306HU-FH Texas Instruments, UCC3626PW National Semiconductor, LM78L05ACMX/NOPB Texas Instruments, SN74AC74PW Apex Microtechnology, HS36, 2.8°C/W Apex Microtechnology, EVAL73 Screw, #4-40 x 1/2" Solder Paste INDC121NCSMQ90 83% MTL MSH-325+500 GP5000S35-0.040-02-43-NA			
R9,R10,R14,R15,R16,R17,R22,R23 RES, 4.99K Vishay, CRCW06034K99FKEA SW1,SW2 Pushbutton, SPST-NO Panasonic, EVQ-Q2B01W TB1 Term. Blk., 5.08mm OSTTA054163 Vert. 5 pos, PCB Apex Microtechnology, SA306HU-FH U2 UCC3626 Texas Instruments, UCC3626PW U3 LM78L05 National Semiconductor, LM78L05ACMX/NOPB U4 74AC74 Texas Instruments, SN74AC74PW Heatsink Apex Microtechnology, HS36, 2.8°C/W PCB, 3.0" x 3.5" Apex Microtechnology, EVAL73 Screw, #4-40 x 1/2" 18-8 SS Pan Head Phillips 91772A110 Paste INDC121NCSMQ90 83% MTL MSH-325+500 (U1) Gap Pad, Thermal Interface, 40mils thick,	R7,R31	RES, 24.9K,1/10W, 1%	
SW1,SW2 Pushbutton, SPST-NO Term. Blk., 5.08mm Panasonic, EVQ-Q2B01W TB1 Term. Blk., 5.08mm OSTTA054163 Vert. 5 pos, PCB Vert. 5 pos, PCB U1 SA306HU-FH Apex Microtechnology, SA306HU-FH U2 UCC3626 Texas Instruments, UCC3626PW U3 LM78L05 National Semiconductor, LM78L05ACMX/NOPB U4 74AC74 Texas Instruments, SN74AC74PW Heatsink Apex Microtechnology, HS36, 2.8°C/W PCB, 3.0" x 3.5" Apex Microtechnology, EVAL73 Screw, #4-40 x 1/2" 18-8 SS Pan Head Phillips 91772A110 Solder Paste INDC121NCSMQ90 83% MTL MSH-325+500 (U1) Gap Pad, Thermal Interface, 40mils thick, GP5000S35-0.040-02-43-NA		· ·	
TB1 Term. Blk., 5.08mm OSTTA054163 Vert. 5 pos, PCB Vert. 5 pos, PCB U1 SA306HU-FH Apex Microtechnology, SA306HU-FH U2 UCC3626 Texas Instruments, UCC3626PW U3 LM78L05 National Semiconductor, LM78L05ACMX/NOPB U4 74AC74 Texas Instruments, SN74AC74PW Heatsink Apex Microtechnology, HS36, 2.8°C/W PCB, 3.0" x 3.5" Apex Microtechnology, EVAL73 Screw, #4-40 x 1/2" 18-8 SS Pan Head Phillips 91772A110 Solder Paste INDC121NCSMQ90 83% MTL MSH-325+500 (U1) Gap Pad, Thermal Interface, 40mils thick,			Vishay, CRCW06034K99FKEA
Vert. 5 pos, PCB			· · · · · · · · · · · · · · · · · · ·
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U2 UCC3626 Texas Instruments, UCC3626PW U3 LM78L05 National Semiconductor, LM78L05ACMX/NOPB U4 74AC74 Texas Instruments, SN74AC74PW Heatsink Apex Microtechnology, HS36, 2.8°C/W PCB, 3.0" x 3.5" Apex Microtechnology, EVAL73 Screw, #4-40 x 1/2" 18-8 SS Pan Head Phillips 91772A110 Solder Paste INDC121NCSMQ90 83% MTL MSH-325+500 (U1) Gap Pad, Thermal Interface, 40mils thick,			
U3 LM78L05 National Semiconductor, LM78L05ACMX/NOPB U4 74AC74 Texas Instruments, SN74AC74PW Heatsink Apex Microtechnology, HS36, 2.8°C/W PCB, 3.0" x 3.5" Apex Microtechnology, EVAL73 Screw, #4-40 x 1/2" 18-8 SS Pan Head Phillips 91772A110 Solder Paste INDC121NCSMQ90 83% MTL MSH-325+500 (U1) Gap Pad, Thermal Interface, 40mils thick,			
U4 74AC74 Texas Instruments, SN74AC74PW Heatsink Apex Microtechnology, HS36, 2.8°C/W PCB, 3.0" x 3.5" Apex Microtechnology, EVAL73 Screw, #4-40 x 1/2" 18-8 SS Pan Head Phillips 91772A110 Solder Paste INDC121NCSMQ90 83% MTL MSH-325+500 (U1) Gap Pad, Thermal Interface, 40mils thick,			
Heatsink PCB, 3.0" x 3.5" Screw, #4-40 x 1/2" Solder Gap Pad, Thermal Interface, 40mils thick, Apex Microtechnology, HS36, 2.8°C/W Apex Microtechnology, EVAL73 18-8 SS Pan Head Phillips 91772A110 Paste INDC121NCSMQ90 83% MTL MSH-325+500 GP5000S35-0.040-02-43-NA			
PCB, 3.0" x 3.5" Apex Microtechnology, EVAL73 Screw, #4-40 x 1/2" 18-8 SS Pan Head Phillips 91772A110 Solder Paste INDC121NCSMQ90 83% MTL MSH-325+500 Gap Pad, Thermal Interface, 40mils thick,	U4		
Screw, #4-40 x 1/2" 18-8 SS Pan Head Phillips 91772A110 Solder Paste INDC121NCSMQ90 83% MTL MSH-325+500 Gap Pad, Thermal Interface, 40mils thick,			
Solder Paste INDC121NCSMQ90 83% MTL MSH-325+500 (U1) Gap Pad, Thermal Interface, 40mils thick,			
(U1) Gap Pad, Thermal GP5000S35-0.040-02-43-NA Interface, 40mils thick,			
Interface, 40mils thick,			
	(U1)	•	GP5000S35-0.040-02-43-NA
1°C/W			
		1°C/W	

4 DB73HUU



DB73HU Quick Start Guide

1. Connect the following:

TABLE 1					
Connection	Location	Indicator	Comment		
Vs	TB1		9-60V		
Ground	TB1				
Vctrl	J5-6	LED 2	12V		
Motor Phase A	TB1				
Motor Phase B	TB1				
Motor Phase C	TB1				
Hall Sensor A	J3-1				
Hall Sensor B	J3-2				
Hall Sensor C	J3-3				
Hall 5V	J3-5		Output from PCB		
Hall ground	J3-6				

- 2. Apply 12V to Vctrl. LED5 should light.
- 3. Apply voltage to Vs based on rated motor voltage, normally 12-48V.
- 4. Press ENABLE SW2. LED2 will light and motor should start.

ORDERING INFORMATION

DB73HU Demonstration Board includes one populated EVAL73 rev B PCB and one SA306HU-FH sample

NEED TECHNICAL HELP? CONTACT APEX SUPPORT!

For all Apex Microtechnology product questions and inquiries, call toll free 800-546-2739 in North America. For inquiries via email, please contact apex.support@apexanalog.com.

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